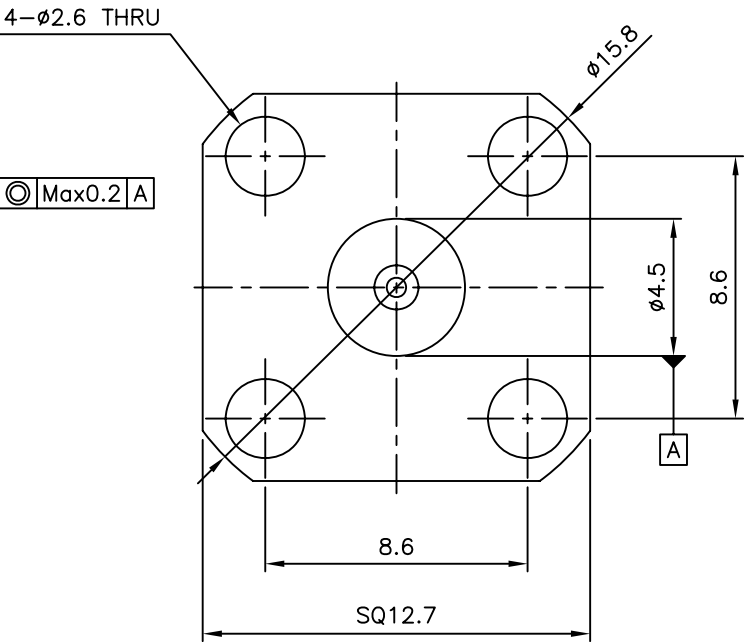
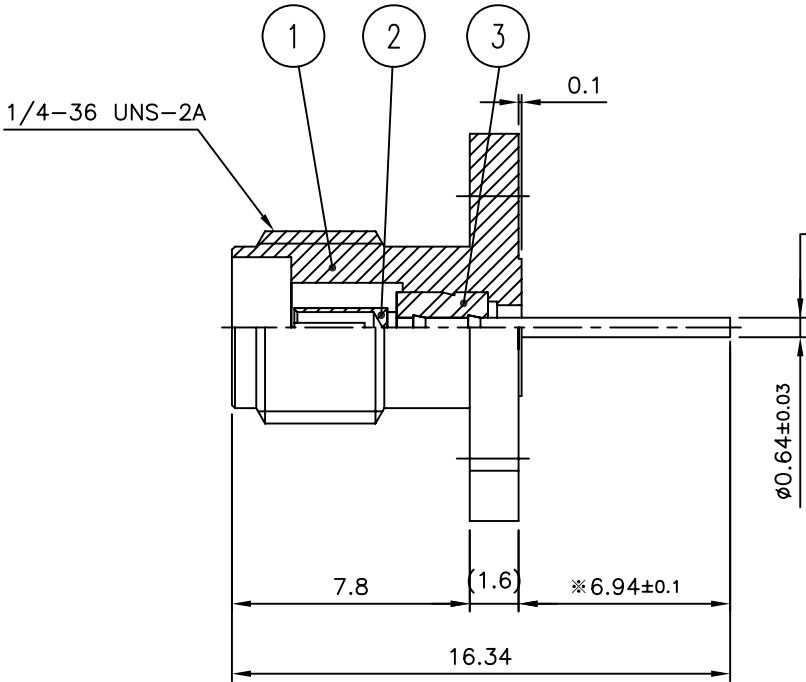


SMA Conn 체결 호환표	
SMA Standard	Male / Female 상호 체결 가능 Male / Female 상호 체결 불가 2.4mm / 1.85mm Male / Female 상호 체결 가능
3.5mm [~26.5GHz]	
2.92mm(K) [~40GHz]	
2.4mm [~50GHz]	
1.85mm(V) [~65GHz]	

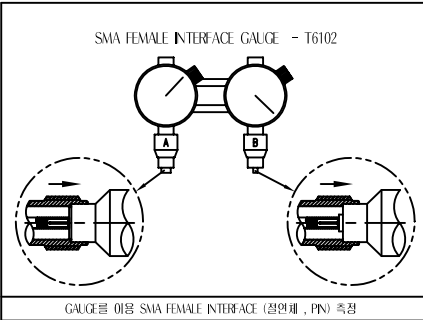
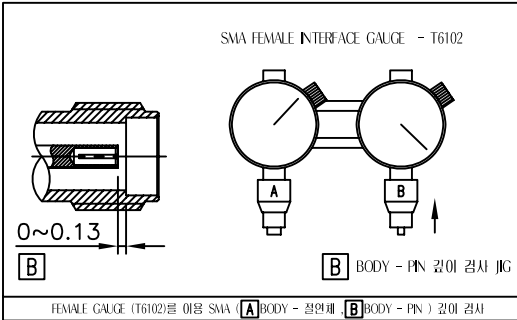
REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	S.Y.EUN	I.C.KIM	2017.07.19.
1	[설번No.201708-0021] PIN 조립 시 MIL SPEC 치수에 맞게 길이 조정	S.Y.EUN	I.C.KIM	2017.08.29.

ELECTRICAL DATA

1. IMPEDANCE : 50ohm
2. FREQUENCY RANGE : DC~40GHz
3. VSWR (Max) : 1.2



* 포장사양 2PAGE 참조



** PIN 높이 검사 방법 **

3	INSULATOR	1	TEFLON		DIN02928-N/1
2	CONTACT	1	BeCu C17300	Gold Plate	DCT03864-5/1
1	BODY	1	MBsBD C3604BD-F	Nickel Plate	DBD04342-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017				
	±0.2	2017. 08. 29.						
	Angle	APPROVED BY	I.C.KIM		KJ COMTECH CO.,LTD.			
	±1°	CHECKED BY						
MATERIAL		DRAWN BY	S.Y.EUN		TITLE			
					SMA(2.92mm)50 SOLDER END JS-4H			
FINISH		SCALE	UNIT		A4			
		4/1	mm			DWG NO.	CN03716-7/1	
					REVISION	1	SHEET	1 of 1



* CN03716-7/1 포장사양 *

1. 부광하이텍 1호 (100구) Tray 사용 - CPA00095-N/1
2. Tray 포장시 각 1EA씩 스티로폼에 끼워서 포장할 것 (사진참조)
 - 스티로폼(110*mm100mm) → 25mm*20mm 잘라서 사용

